PHOTO REFLECTOR

■ GENERAL DESCRIPTION

The NJL5171K is the single-in-line super miniature, super thin type photo Reflector, which consist of high output power LED and high sensitve Si photo transistor.

■ FEATURES

- Super miniature, Super thin type
- Built-in visible light cut off filter
- High output, High S/N ratio

■ APPLICATIONS

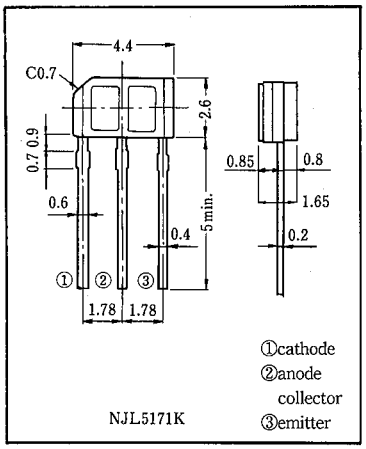
- End detector of video, audio tape etc.
- Rotation detection and control of various motors, audio turntables.
- Paper edge detection of facsimile, printer, X-Y recorder, so on.
- Line code reading, encorder and the automatic vending machine etc.
- FDD, Robot, and other detecton of industrial systems.

■ ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

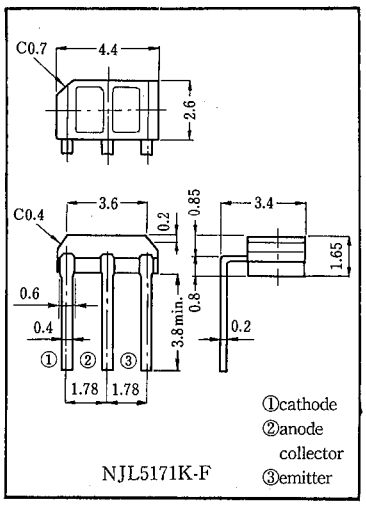
PARAMETER	SYMBOL	RATINGS	UNIT
Emitter			
Forward Current (Continuous)	I_F	50	mA
Pulse Forward Current	I_{FP}	500(note 1)	mA
Reverse Voltage (Continuous)	V_R	6	V
Power Dissipation	P_D	75	mW
Detector			
Collector-Emitter Voltage	V_{CEO}	25	V
Emitter-Collector Voltage	V_{ECO}	6	V
Collector Current	I_C	20	mA
Collector Power Dissipation	P_C	75	mW
Coupled			
Total Power Dissipation	P_{tot}	100	mW
Operating Temperature	T_{opr}	−20～+90	°C
Storage Temperature	T_{stg}	−30～+100	°C
Soldering Temperature	T_{sol}	260 (10sec. 1.5mm from body)	°C

(note 1) Pulse width≦10μs, Duty Ratio 0.01

■ OUTLINE (typ.) Unit: mm



■ OUTLINE (typ.) Unit: mm



2

■ ELECTRO-OPTICAL CHARACTERISTICS (Ta=25°C)

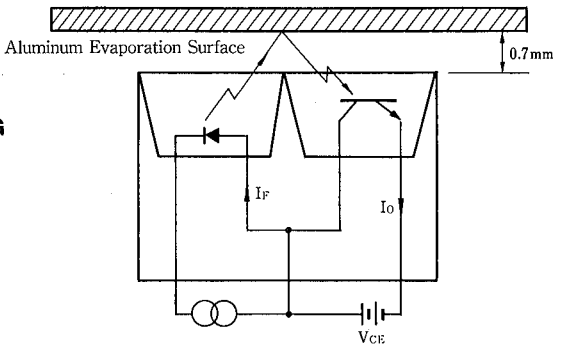
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Emitter						
Forward-Voltage	V_F	I_F=4mA	—	—	1.2	V
Reverse-Current	I_R	V_R=6V	—	—	1	μA
Capacitance	C_t	V_R=0V, f=1MHz	—	25	—	pF
Detector						
Dark Current	I_{CEO}	V_{CE}=10V	—	—	200	nA
Collector-Emitter Voltage	V_{CEO}	I_C=100μA	25	—	—	V
Emitter-Collector Current	I_{ECO}	V_{EC}=6V	—	—	100	μA
Coupled						
Output Current	I_O	I_F=4mA, V_{CE}=2V, d=0.7mm	50	—	160	μA
Operating Dark Current	I_{CEOD}	I_F=4mA, V_{CE}=2V	—	—	100	nA
Rise Time	t_r	V_{CE}=2V, I_F=4mA, R_L=1kΩ, d=0.7mm	—	20	—	μs
Fall Time	t_f	〃	—	20	—	μs

■ RANK OF OUTPUT CURRENT

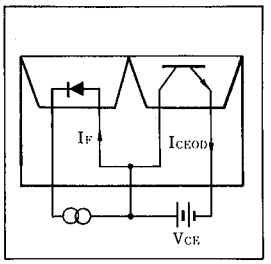
RANK	G	H
I_O (μA)	70~160	50~110

■ MEASURING SPECFICATION FOR OUTPUT CURRENT

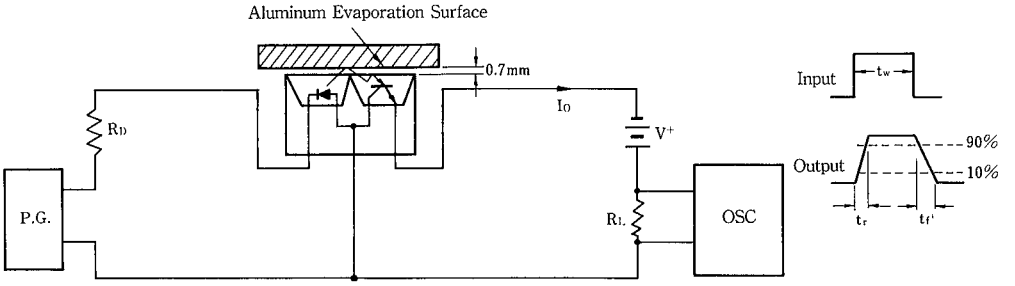
The Output current can be measured when reflected at the Aluminum evaporation mirror.



■ MEASURING CRICUIT FOR OPERATING DARK CURRENT

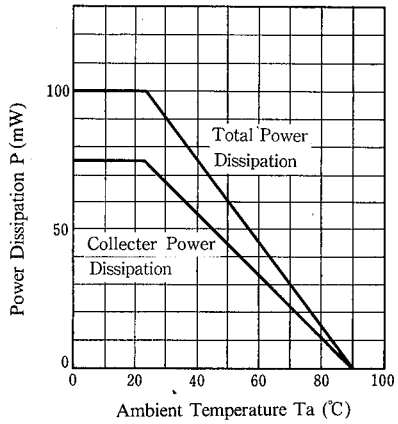


■ MEASURING CRICUIT FOR SWITCHING TIME

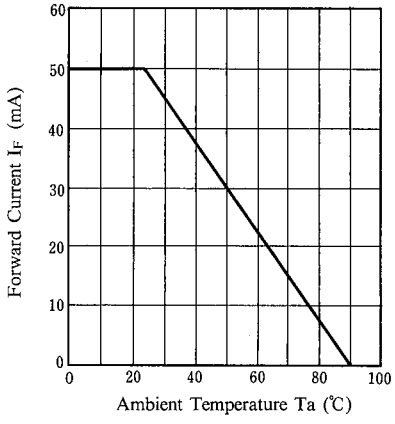


■ MAXIMUM RATING CURVES

Power Dissipation vs. Temperature

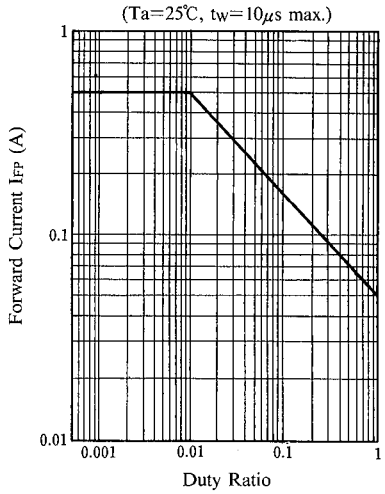


Forward Current vs. Temperature



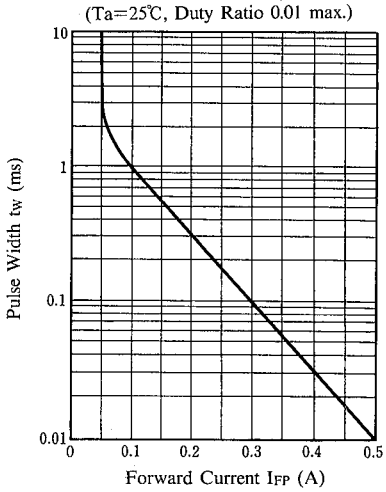
Pulse Forward Current vs. Duty Ratio

(Ta=25℃, tw=10μs max.)



Pulse Width vs. Forward Current

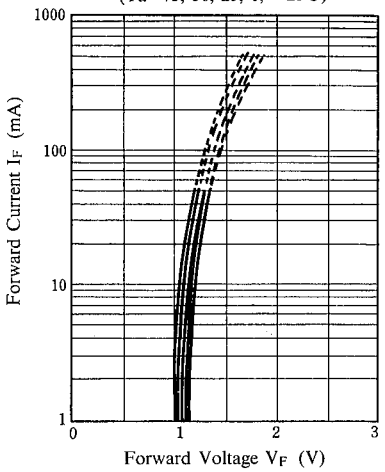
(Ta=25℃, Duty Ratio 0.01 max.)



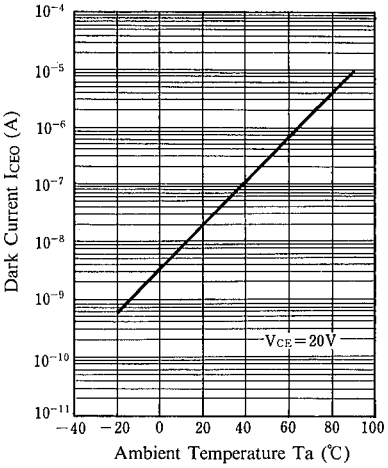
■ TYPICAL CHARACTERISTICS

Forward Current vs. Forward Voltage

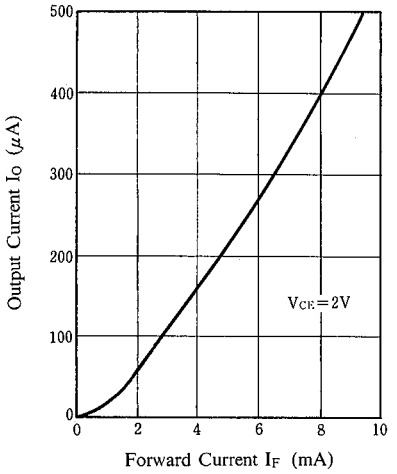
(Ta=75, 50, 25, 0, −25℃)



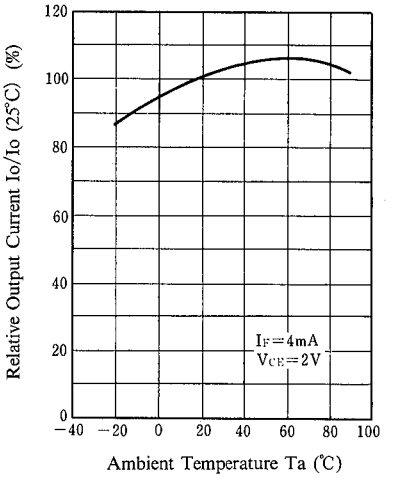
Dark Current vs. Temperature



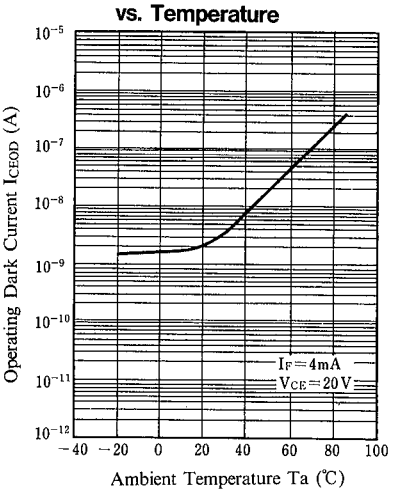
Output Current vs. Forward Current (Ta=25℃)



Output Current vs. Temperature



Operating Dark Current vs. Temperature



PRECAUTION FOR HANDLING

1. Soldering

1) Avoid the reflow method and the solder to touch the body of the device during wave soldering. This is to prevent changes in optical characteristics of the device.
2) Recommended in Soldering

Temperature	Time Lead	Soldering Position
260℃ maximum	less than 10 seconds	At least 1.5mm from body

3) Soldering is recommended to be done in as short period of the time as possible by controlling the temperature of the soldering iron or by the iron of less than 15 watts.
4) The resin gets softened right after soldered, so, the following care has to be taken.
   - Not to contact the lens surface to anything
   - Not to dip the device into water or any solvents
5) It is recommended not to solder when the leads or between the lead get pulled, depressed or twisted.
6) In the case of using rosin flux, be careful to avoid contact with the lens surface. If the lens is covered with the flux, the specified characteristics cannot be achieved.

2. Post Solder Cleaning

1) Organic solvents for flux removal like trichloroethlene, acetone, thinner etc, might attack the lens surface. It is preferable to use less reactive solvents, Methyl Alcohol, Isopropyle Alcohol.
2) Cleaning Operation
   Cleaning Solvent Temperature : 35℃ maximum
   Dipping Time : 3 minute maximum

3. Attention in handling

1) Treat not to touch the lens surface.
2) Avoid dust and any other foreign materials(flux, paint, bonding material, etc)on the lens surface.
3) Never to apply reverse voltage(V_{EC}) of more than 6V on the photo transistor when measuring the characteristics or adjusting the system. If applied, it causes to lower the sensitivity.
4) When mounting, special care has to be taken on the mounting position and tilting of the device because it is very important to place the device to the optimum position to the object.

4. Storage

The leads are silver plated and they are discolored if the device is left open to the air for long after taken out of the envelope. It causes deterioration of soldering characteristics. Mount the device as short as possible after opening the envelope.

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